

L Number	Hits	Search Text	DB	Time stamp
1	2	"20020050632"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 11:53
2	252	\$3Fe?sub.2O?sub.4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 11:58
3	11514	( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (shield\$3 PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) )	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:21
4	2046	(( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (shield\$3 PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) ) ) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:16
5	1675	(( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (shield\$3 PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) ) ) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide) ) and @ad<20000831	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:16
6	9957	( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) )	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:22
7	1736	(( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) ) ) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:16
8	1441	(( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) ) ) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide) ) and @ad<20000831	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:17
9	237	(( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) ) ) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide) ) and @rlad<20000831	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:17
10	1474	(( (( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) ) ) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide) ) and @ad<20000831) ((( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) ) ) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide) ) and @rlad<20000831)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:17

11	1784	( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 shield\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:18
12	70	(((( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) )) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide) ) and @ad<20000831) ((( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) )) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide) ) and @rlad<20000831)) and (( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 shield\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:18
13	45	(((( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) )) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide) ) and @ad<20000831) ((( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 (PWB PCB carrier substrate (lead adj frame) interposer (printed adj2 (circuit wiring)) )) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide) ) and @rlad<20000831)) and (( (magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4") ) near12 shield\$3)) and (circuit chip die semiconductor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/29 12:22